



## AGENDA

# Davis Technical College Board of Trustees Meeting

Thursday, September 16, 2024 | 3:30 p.m. | Haven J. Barlow Board Room

Meeting will be conducted in-person/electronically.

Anchor location: Davis Technical College, 550 E 300 S, Kaysville, UT 84037.

Items open to the public can be accessed electronically by requesting information through email by 12:00 p.m. on the date of the meeting to [wendee.cole@davistech.edu](mailto:wendee.cole@davistech.edu).

1.	Welcome, Roll Call, and Introduction of Special Guests		Chair Wood
2.	Pledge of Allegiance: Ryan Schoebel (Electrician Apprenticeship student)		Instructor Swapp
3.	Introduction of International HOSA and National SkillsUSA Winners	Item 3	Vice President Mock
4.	Public Comment		Chair Wood
5.	Consent Calendar Approval	Item 5	Chair Wood
	a. Minutes of May 16, 2024 meeting	Item 5a	
	b. Budget and Accounting, and Investment Report	Item 5b	
	c. Key Performance Indicators Report	Item 5c	
	d. Business and Economic Development Report	Item 5d	
	e. Foundation Activity Report	Item 5e	
	f. Campus Development Update	Item 5f	
	g. Scholarship Issuance Report	Item 5g	
	h. Career Path High Report	Item 5h	
	i. Admissions and Registration Policy	Item 5i	
	j. Employment-At-Will Policy	Item 5j	
	k. GRAMA Policy and Procedures	Item 5k	
	l. Rescind Faculty Sabbatical Leave Policy	Item 5l	
	m. Appointment to Career Path High Board	Item 5m	
6.	Facilities Plan Approval	Item 6	Vice President Lund
	a. 5-Year Capital Facilities Plan	Item 6a	
	b. FY 2026 Capital Improvement Project		
7.	Audit Committee Report	Item 7	Trustee Merrihew/ Vice President Lund
8.	Key Performance Indicator (KPI) Report and FY 2025 Enrollment Update	Item 8	Vice President Simerick/ Director Horne
9.	FY 2026 Appropriations Request Approval	Item 9	President Brush
10.	President's Report	Item 10	President Brush
11.	CLOSED Session: President's Evaluation	Item 11	Chair Wood
12.	Adjourn		

The Board may elect to go into a closed session, which will not be open to the public, pursuant to Utah Code Title 52, Chapter 4, Sections 204, 205 and 206.